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Details

Product Status	Discontinued at Digi-Key
Core Processor	Z8
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	PWM, WDT
Number of I/O	13
Program Memory Size	1KB (1K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8e00110ssc

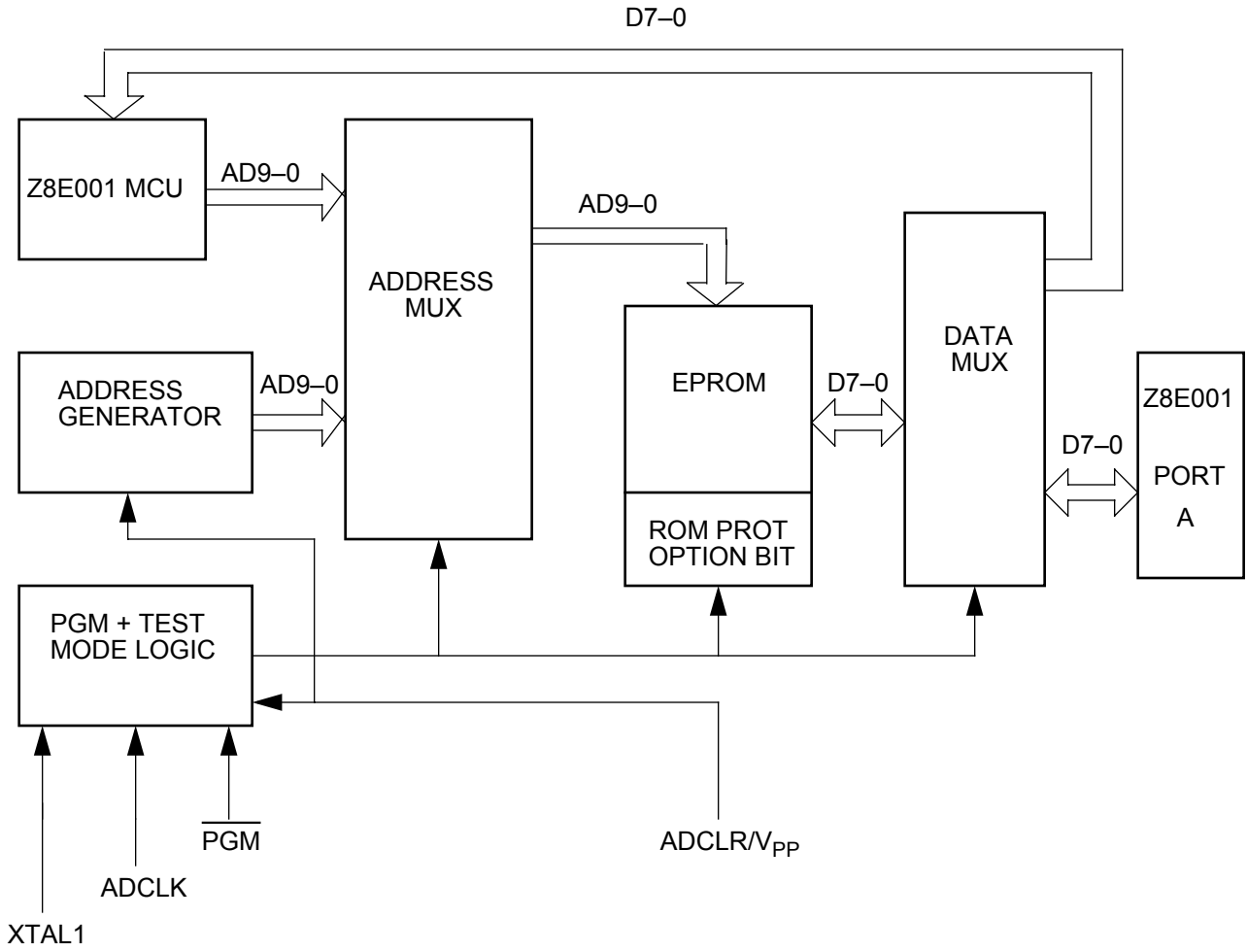


Figure 2. EPROM Programming Mode Block Diagram

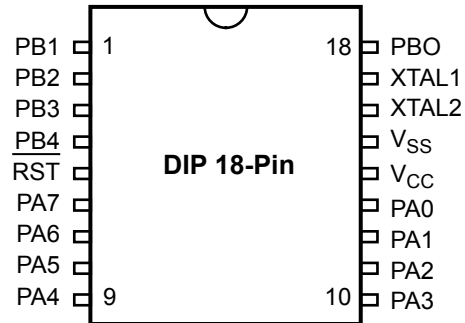


Figure 4. 18-Pin DIP/SOIC Pin Identification

Standard Mode

Pin #	Symbol	Function	Direction
1–4	PB1–PB4	Port B, Pins 1,2,3,4	Input/Output
5	RESET	Reset	Input
6–9	PA7–PA4	Port A, Pins 7,6,5,4	Input/Output
10–13	PA3–PA0	Port A, Pins 3,2,1,0	Input/Output
14	V _{CC}	Power Supply	
15	V _{SS}	Ground	
16	XTAL2	Crystal Osc. Clock	Output
17	XTAL1	Crystal Osc. Clock	Input
18	PB0	Port B, Pin 0	Input/Output

PIN DESCRIPTION (Continued)

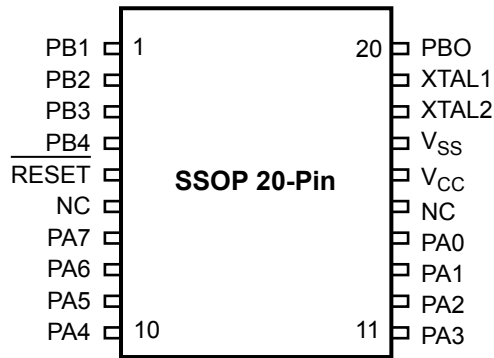


Figure 5. 20-Pin SSOP Pin Identification

Standard Mode

Pin #	Symbol	Function	Direction
1–4	PB1–PB4	Port B, Pins 1,2,3,4	Input/Output
5	RESET	Reset	Input
6	NC	No Connection	
7–10	PA7–PA4	Port A, Pins 7,6,5,4	Input/Output
11–14	PA3–PA0	Port A, Pins 3,2,1,0	Input/Output
15	NC	No Connection	
16	V _{CC}	Power Supply	
17	V _{SS}	Ground	
18	XTAL2	Crystal Osc. Clock	Output
19	XTAL1	Crystal Osc. Clock	Input
20	PB0	Port B, Pin 0	Input/Output

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 7).

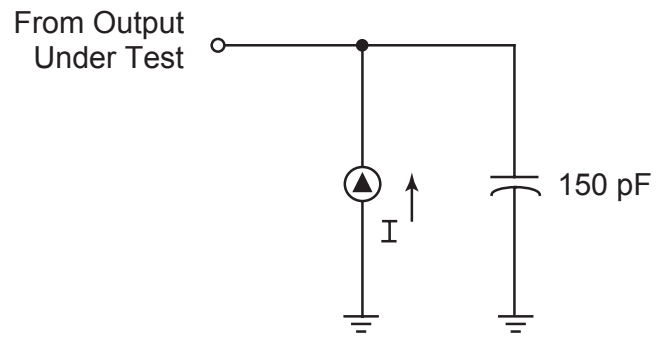


Figure 7. Test Load Diagram

CAPACITANCE

$T_A = 25^\circ\text{C}$, $V_{CC} = \text{GND} = 0\text{V}$, $f = 1.0\text{ MHz}$, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF

DC ELECTRICAL CHARACTERISTICS

Table 1. DC Electrical Characteristics

Sym	Parameter	pF T _A = 0°C to +70°C Standard Temperatures				Typical ² @ 25°C	Units	Conditions	Notes
		V _{CC} ¹	Min	Max					
V _{CH}	Clock Input High Voltage	3.5V	0.7V _{CC}	V _{CC} +0.3	1.3	V	Driven by External Clock Generator		
		5.5V	0.7V _{CC}	V _{CC} +0.3	2.5	V	Driven by External Clock Generator		
V _{CL}	Clock Input Low Voltage	3.5V	V _{SS} -0.3	0.2V _{CC}	0.7	V	Driven by External Clock Generator		
		5.5V	V _{SS} -0.3	0.2V _{CC}	1.5	V	Driven by External Clock Generator		
V _{IH}	Input High Voltage	3.5V	0.7V _{CC}	V _{CC} +0.3	1.3	V			
		5.5V	0.7V _{CC}	V _{CC} +0.3	2.5	V			
V _{IL}	Input Low Voltage	3.5V	V _{SS} -0.3	0.2V _{CC}	0.7	V			
		5.5V	V _{SS} -0.3	0.2V _{CC}	1.5	V			
V _{OH}	Output High Voltage	3.5V	V _{CC} -0.4		3.1	V	I _{OH} = -2.0 mA		
		5.5V	V _{CC} -0.4		4.8	V	I _{OH} = -2.0 mA		
V _{OL1}	Output Low Voltage	3.5V		0.6	0.2	V	I _{OL} = +4.0 mA		
		5.5V		0.4	0.1	V	I _{OL} = +4.0 mA		
V _{OL2}	Output Low Voltage	3.5V		1.2	0.5	V	I _{OL} = +6 mA		
		5.5V		1.2	0.5	V	I _{OL} = +12 mA		
V _{RH}	Reset Input High Voltage	3.5V	0.5V _{CC}	V _{CC}	1.1	V			
		5.5V	0.5V _{CC}	V _{CC}	2.2	V			
V _{RL}	Reset Input Low Voltage	3.5V	V _{SS} -0.3	0.2V _{CC}	0.9	V			
		5.5V	V _{SS} -0.3	0.2V _{CC}	1.4	V			
V _{OFFSET}	Comparator Input Offset Voltage	3.5V		25.0	10.0	mV			
		5.5V		25.0	10.0	mV			
I _{IL}	Input Leakage	3.5V	-1.0	2.0	0.064	mA	V _{IN} = 0V, V _{CC}		
		5.5V	-1.0	2.0	0.064	mA	V _{IN} = 0V, V _{CC}		
I _{OL}	Output Leakage	3.5V	-1.0	2.0	0.114	μA	V _{IN} = 0V, V _{CC}		
		5.5V	-1.0	2.0	0.114	μA	V _{IN} = 0V, V _{CC}		
V _{ICR}	Comparator Input Common Mode Voltage Range	3.5V	V _{SS} -0.3	V _{CC} -1.0		V		3	
		5.5V	V _{SS} -0.3	V _{CC} -1.0		V		3	
I _{IR}	Reset Input Current	3.5V	-10	-60	-30	μA			
		5.5V	-20	-180	-100	μA			

Table 1. DC Electrical Characteristics (Continued)

pF $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$ Standard Temperatures								
Sym	Parameter	V_{CC}^1	Min	Max	Typical ² @ 25°C	Units	Conditions	Notes
I_{CC}	Supply Current	3.5V		2.5	2.0	mA	@ 10 MHz	4,5
		5.5V		6.0	3.5	mA	@ 10 MHz	4,5
I_{CC1}	Standby Current	3.5V		2.0	1.0	mA	HALT Mode $V_{IN} = 0V$, V_{CC} @ 10 MHz	4,5
		5.5V		4.0	2.5	mA	HALT Mode $V_{IN} = 0V$, V_{CC} @ 10 MHz	4,5
I_{CC2}	Standby Current	3.5V		500	150	nA	STOP Mode $V_{IN} = 0V$, V_{CC}	6

Notes:

1. The V_{CC} voltage specification of 3.5V guarantees 3.5V and the V_{CC} voltage specification of 5.5 V guarantees 5.0 V ± 0.5 V.
2. Typical values are measured at $V_{CC} = 3.3V$ and $V_{CC} = 5.0V$; $V_{SS} = 0V = GND$.
3. For analog comparator input when analog comparator is enabled.
4. All outputs unloaded and all inputs are at V_{CC} or V_{SS} level.
5. $CL1 = CL2 = 22$ pF.
6. Same as note 4 except inputs at V_{CC} .

Table 2. DC Electrical Characteristics (Continued)

T _A = -40°C to +105°C Extended Temperatures								
Sym	Parameter	V _{CC} ¹	Min	Max	Typical ² @ 25°C	Units	Conditions	Notes
I _{CC}	Supply Current	4.5V		7.0	4.0	mA	@ 10 MHz	4,5
		5.5V		7.0	4.0	mA	@ 10 MHz	4,5
I _{CC1}	Standby Current	4.5V		2.0	1.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 10 MHz	4,5
		5.5V		2.0	1.0	mA	HALT Mode V _{IN} = 0V, V _{CC} @ 10 MHz	4,5
I _{CC2}	Standby Current	4.5V		700	250	nA	STOP Mode V _{IN} = 0V, V _{CC}	6
		5.5V		700	250	nA	STOP Mode V _{IN} = 0V, V _{CC}	6

Notes:

1. The V_{CC} voltage specification of 4.5V and 5.5V guarantees 5.0V ±0.5V.
2. Typical values are measured at V_{CC} = 3.3V and V_{CC} = 5.0V; V_{SS} = 0V = GND.
3. For analog comparator input when analog comparator is enabled.
4. All outputs unloaded and all inputs are at V_{CC} or V_{SS} level.
5. CL1 = CL2 = 22 pF.
6. Same as note 4 except inputs at V_{CC}.

Z8PLUS CORE

The Z8E001 is based on the ZiLOG Z8Plus Core Architecture. This core is capable of addressing up to 64KBytes of program memory and 4KBytes of RAM. Register RAM is accessed as either 8 or 16 bit registers using a combination of 4, 8, and 12 bit addressing modes. The architecture sup-

ports up to 15 vectored interrupts from external and internal sources. The processor decodes 44 CISC instructions using six addressing modes. See the Z8Plus User's Manual for more information.

RESET

This section describes the Z8E001 reset conditions, reset timing, and register initialization procedures. Reset is generated by the Reset Pin, Watch-Dog Timer (WDT), and Stop-Mode Recovery (SMR).

A system reset overrides all other operating conditions and puts the Z8E001 into a known state. To initialize the chip's internal logic, the RESET input must be held Low for at least 30 XTAL clock cycles. The control registers and ports

are reset to their default conditions after a reset from the RESET pin. The control registers and ports are not reset to their default conditions after wakeup from Stop Mode or WDT timeout.

During RESET, the program counter is loaded with 0020H. I/O ports and control registers are configured to their default reset state. Resetting the Z8E001 does not affect the contents of the general-purpose registers.

RESET PIN OPERATION

The Z8E001 hardware RESET pin initializes the control and peripheral registers, as shown in Table 4. Specific reset values are shown by 1 or 0, while bits whose states are unchanged or unknown from Power-Up are indicated by the letter U.

RESET must be held Low until the oscillator stabilizes, for an additional 30 XTAL clock cycles, in order to be sure that the internal reset is complete. The RESET pin has a Schmitt-Trigger input with a trip point. There is no High side protection diode. The user should place an external diode from

RESET to V_{CC} . A pull-up resistor on the RESET pin is approximately 500 K Ω , typical.

Program execution starts 10 XTAL clock cycles after RESET has returned High. The initial instruction fetch is from location 0020H. Figure 9 indicates reset timing.

After a reset, the first routine executed must be one that initializes the TCTLHI control register to the required system configuration, followed by initialization of the remaining control registers.

Table 4. Control and Peripheral Registers

Register (HEX)	Register Name	Bits								Comments
		7	6	5	4	3	2	1	0	
FF	Stack Pointer	0	0	U	U	U	U	U	U	Stack pointer is not affected by RESET
FE	Reserved									
FD	Register Pointer	U	U	U	U	0	0	0	0	Register pointer is not affected by RESET
FC	Flags	U	U	U	U	U	U	*	*	Only WDT & SMR flags are affected by RESET
FB	Interrupt Mask	0	0	0	0	0	0	0	0	All interrupts masked by RESET
FA	Interrupt Request	0	0	0	0	0	0	0	0	All interrupt requests cleared by RESET
F9–F0	Reserved									
EF–E0	Virtual Copy									Virtual Copy of the Current Working Register Set
DF–D8	Reserved									

Z8E001 WATCH-DOG TIMER (WDT)

The WDT is a retriggerable one-shot 16-bit timer that resets the Z8E001 if it reaches its terminal count. The WDT is driven by the XTAL2 clock pin. To provide the longer timeout periods required in applications, the watchdog timer is only updated every 64th clock cycle. When operating in the RUN or HALT Modes, a WDT timeout reset is functionally equivalent to an interrupt vectoring the PC to 0020H and setting the WDT flag to a one state. Coming out of RESET, the WDT is fully enabled with its timeout value set at the maximum value, unless otherwise programmed during the first instruction. Subsequent executions of the WDT instruction, reinitialize the watchdog timer registers (C2H and C3H), to their initial values as defined by bits D6, D5, and D4 of the TCTLHI register. The WDT cannot be disabled except on the first cycle after RESET, and if the device enters Stop mode.

The WDT instruction should be executed often enough to provide some margin before allowing the WDT registers to

get near 0. Because the WDT timeout periods are relatively long, a WDT reset will occur in the unlikely event that the WDT times out on exactly the same cycle that the WDT instruction is executed.

The WDT and SMR flags are the only flags that are affected by the external RESET pin. RESET clears both the WDT and SMR flags. A WDT timeout sets the WDT flag. The STOP instruction sets the SMR flag. This behavior enables software to determine whether a pin RESET occurred, or whether a WDT timeout occurred, or whether a return from STOP Mode occurred. Reading the WDT and SMR flags does not reset it to zero, the user must clear it via software.

Note: Failure to clear the SMR flag can result in undefined behavior.

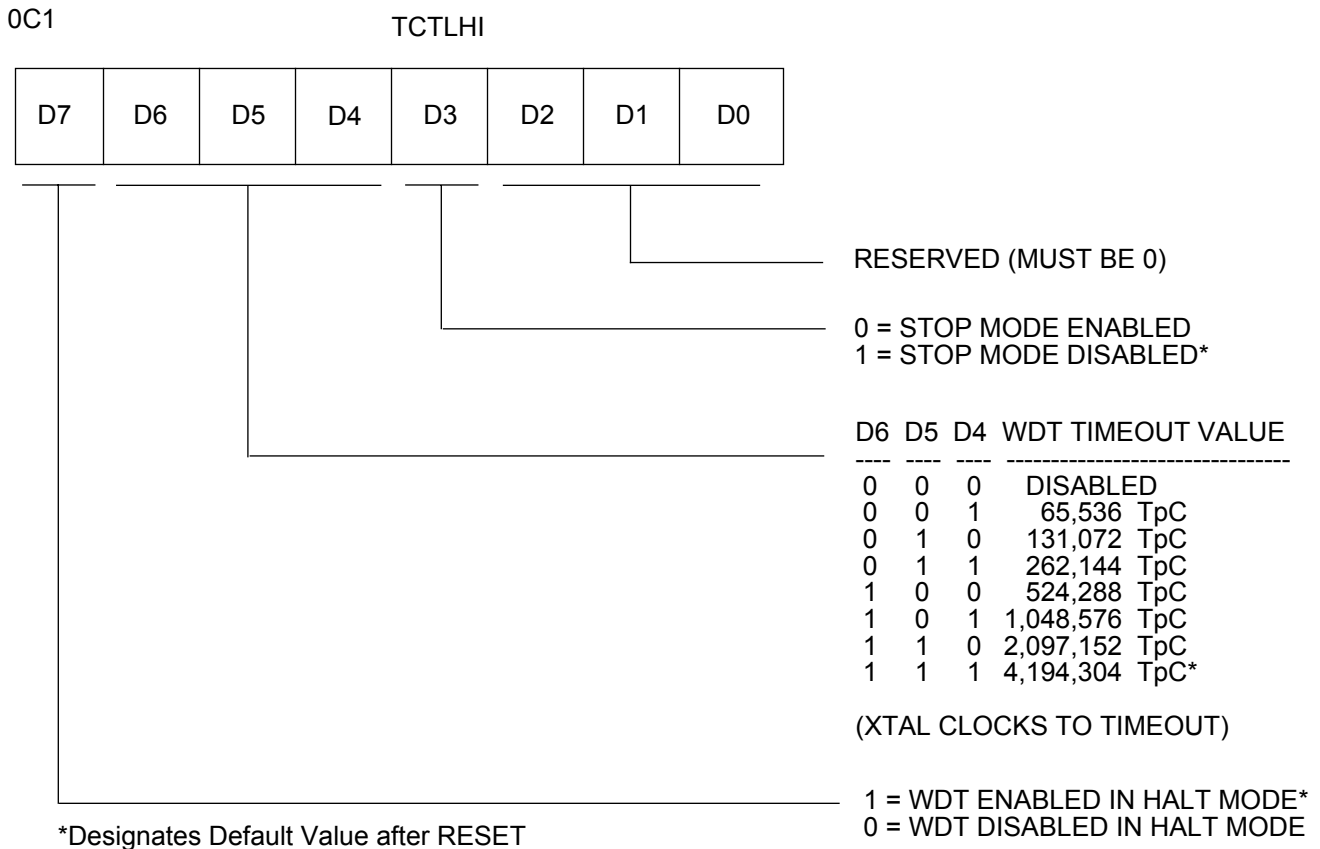


Figure 12. Z8E001 TCTLHI Register for Control of WDT

STOP MODE OPERATION

The STOP Mode provides the lowest possible device standby current. This instruction turns off the on-chip oscillator and internal system clock.

To enter the STOP Mode, the Z8E001 only requires a STOP instruction. It is NOT necessary to execute a NOP instruction immediately before the STOP instruction.

```
6F  STOP ;enter STOP Mode
```

The STOP Mode is exited by any one of the following resets: RESET pin or a STOP-Mode Recovery source. Upon reset generation, the processor always restarts the application program at address 0020H, and the STOP Mode Flag is set. Reading the STOP Mode Flag does not clear it. The user must clear the STOP Mode Flag with software.

Note: Failure to clear the STOP Mode Flag can result in undefined behavior.

The Z8E001 provides a dedicated STOP-Mode Recovery (SMR) circuit. In this case, a low-level applied to input pin PB0 triggers an SMR. To use this mode, pin PB0 (I/O Port B, bit 0) must be configured as an input before the STOP Mode is entered. The Low level on PB0 must be held for a minimum pulse width T_{WSM} plus any oscillator startup time. Program execution starts at address 20Hex after PB0 is raised back to a high level.

Notes: Use of the PB0 input for the stop mode recovery does not initialize the control registers.

The STOP Mode current (I_{CC2}) is minimized when:

- V_{CC} is at the low end of the devices operating range.
- Output current sourcing is minimized.
- All inputs (digital and analog) are at the Low or High rail voltages.

CLOCK

The Z8E001 MCU derives its timing from on-board clock circuitry connected to pins XTAL1 and XTAL2. The clock circuitry consists of an oscillator, a glitch filter, a divide-by-two shaping circuit, a divide-by-four shaping circuit, and a divide-by-eight shaping circuit. Figure 13 illustrates the clock circuitry. The oscillator's input is XTAL1 and its output is XTAL2. The clock can be driven by a crystal, a ceramic resonator, LC clock, or an external clock source.

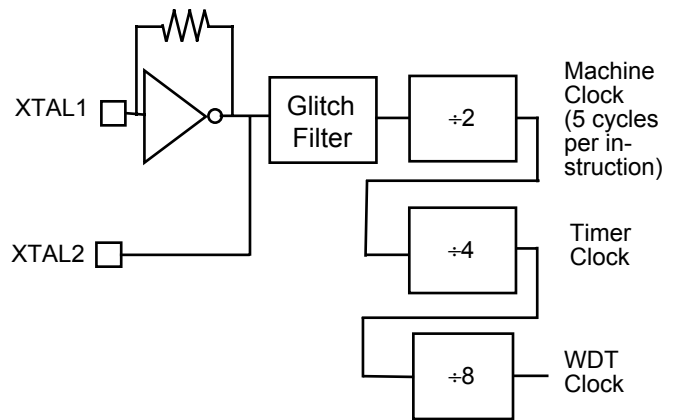
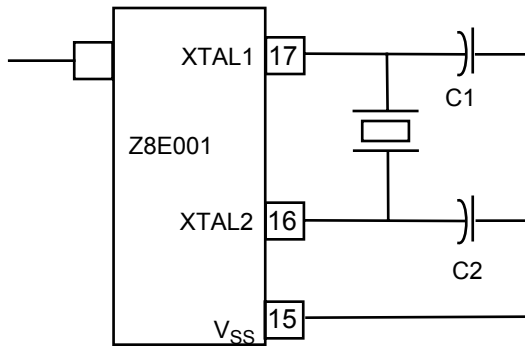
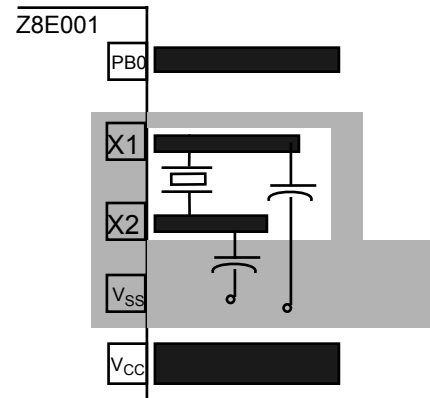
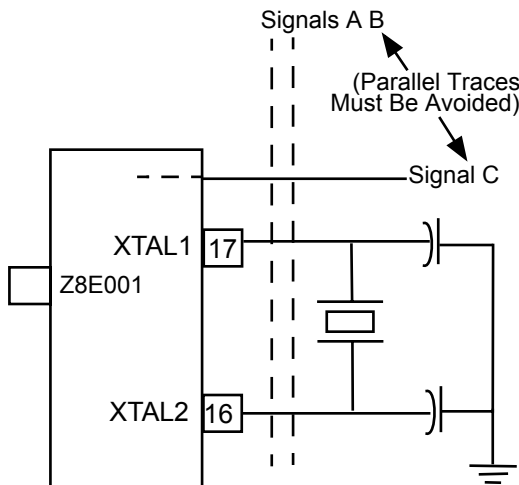


Figure 13. Z8E001 Clock Circuit

- V_{CC} power lines should be separated from the clock oscillator input circuitry.
- Resistivity between XTAL1 or XTAL2 (and the other pins) should be greater than 10 M Ω .



Clock Generator Circuit



Board Design Example
(Top View)

Figure 15. Circuit Board Design Rules

Crystals and Resonators

Crystals and ceramic resonators (Figure 16) should have the following characteristics to ensure proper oscillation:

Crystal Cut	AT (crystal only)
Mode	Parallel, Fundamental Mode
Crystal Capacitance	<7pF
Load Capacitance	10pF < CL < 220 pF, 15 typical
Resistance	100 ohms max

Depending on the operation frequency, the oscillator can require additional capacitors, C1 and C2, as shown in Figure 16 and Figure 17. The capacitance values are dependent on the manufacturer's crystal specifications.

LC OSCILLATOR

The Z8E001 oscillator can use a LC network to generate a XTAL clock (Figure 17).

The frequency stays stable over V_{CC} and temperature. The oscillation frequency is determined by the equation:

$$\text{Frequency} = \frac{1}{2\pi (LC_T)^{1/2}}$$

where L is the total inductance including parasitics, and C_T is the total series capacitance including parasitics.

Simple series capacitance is calculated using the equation at the top of the next column.

$$1/C_T = 1/C_1 + 1/C_2$$

$$\text{If } C_1 = C_2$$

$$1/C_T = 2/C_1$$

$$C_1 = 2C_T$$

A sample calculation of capacitance C_1 and C_2 for 5.83 MHz frequency and inductance value of 27 μH is displayed as follows:

$$5.83 (10^6) = \frac{1}{2\pi [2.7 (10^{-6}) C_T]^{1/2}}$$

$$C_T = 27.6 \text{ pF}$$

Thus $C_1 = 55.2 \text{ pF}$ and $C_2 = 55.2 \text{ pF}$.

TIMERS

For the Z8E001, 8-bit timers (T0 and T1) are available to function as a pair of independent 8-bit standard timers, or they can be cascaded to function as a 16-bit PWM timer.

In addition to T0 and T1, extra 8-bit timers (T2 and T3) are provided, but they can only operate in cascade to function as a 16-bit standard timer.

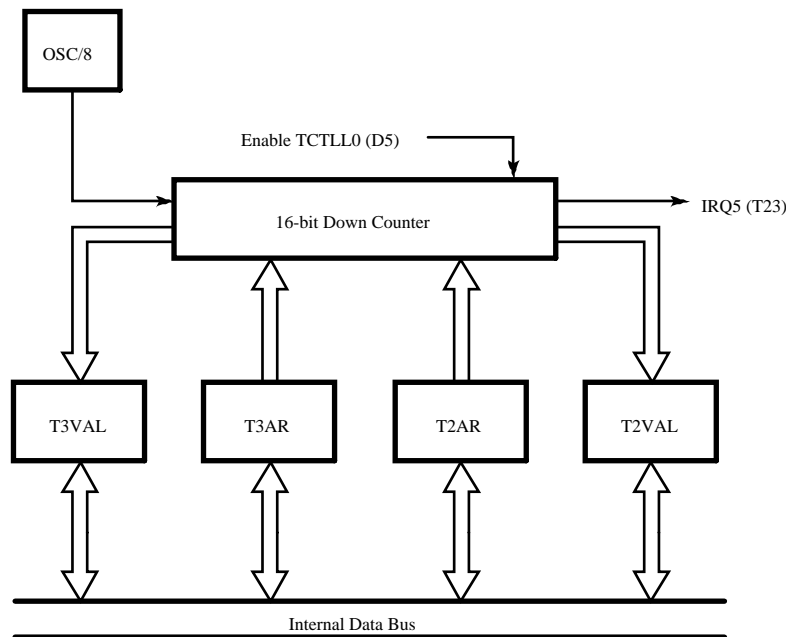
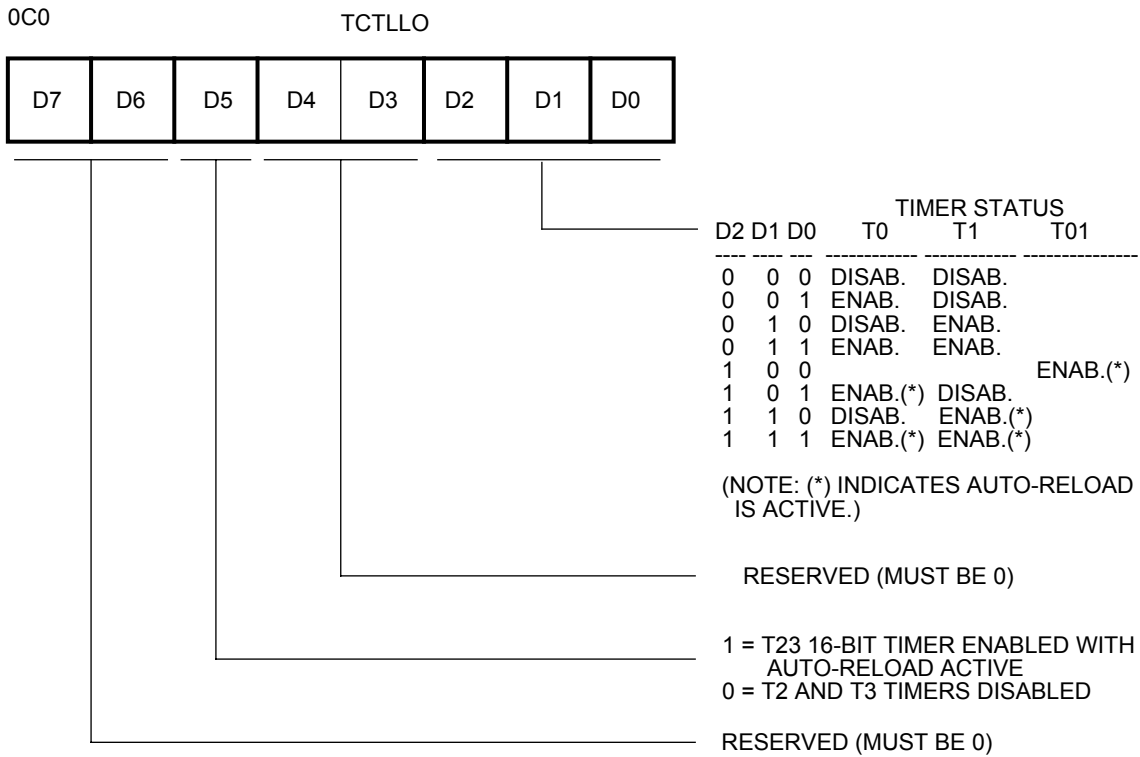


Figure 19. Z8E001 16-Bit Standard Timer



Note: Timer T01 is a 16-bit PWM Timer formed by cascading 8-bit timers T1 (MSB) and T0 (LSB). T23 is a standard 16-bit timer formed by cascading 8-bit timers T3 (MSB) and T2 (LSB).

Figure 22. TCTLLO Register

Each 8-bit timer is provided a pair of registers, which are both readable and writable. One of the registers is defined to contain the auto-initialization value for the timer, while the second register contains the current value for the timer. When a timer is enabled, the timer decrements whatever value is currently held in its count register, and then continues decrementing until it reaches 0. At this time, an interrupt is generated and the contents of the auto-initialization register optionally copy into the count value register. If auto-initialization is not enabled, the timer stops counting upon reaching 0, and control logic clears the appropriate control register bit to disable the timer. This operation is referred to as “single-shot”. If auto-initialization is enabled, the timer continues counting from the initialization value. Software should not attempt to use registers that are defined as having timer functionality.

Software is allowed to write to any register at any time, but care should be taken if timer registers are updated while the timer is enabled. If software updates the count value while the timer is in operation, the timer continues counting based upon the software-updated value.

Note: Strange behavior can result if the software update occurred at exactly the point that the timer was reaching 0 to trigger an interrupt and/or reload.

Similarly, if software updates the initialization value register while the timer is active, the next time that the timer reaches 0, it initializes using the updated value.

Note: Strange behavior could result if the initialization value register is being written while the timer is in the process of being initialized.

Whether initialization is done with the new or old value is a function of the exact timing of the write operation. In all cases, the Z8E001 prioritizes the software write above that of a decremter writeback; however, when hardware clears a control register bit for a timer that is configured for single-shot operation, the clearing of the control bit overrides a software write. Reading either register can be done

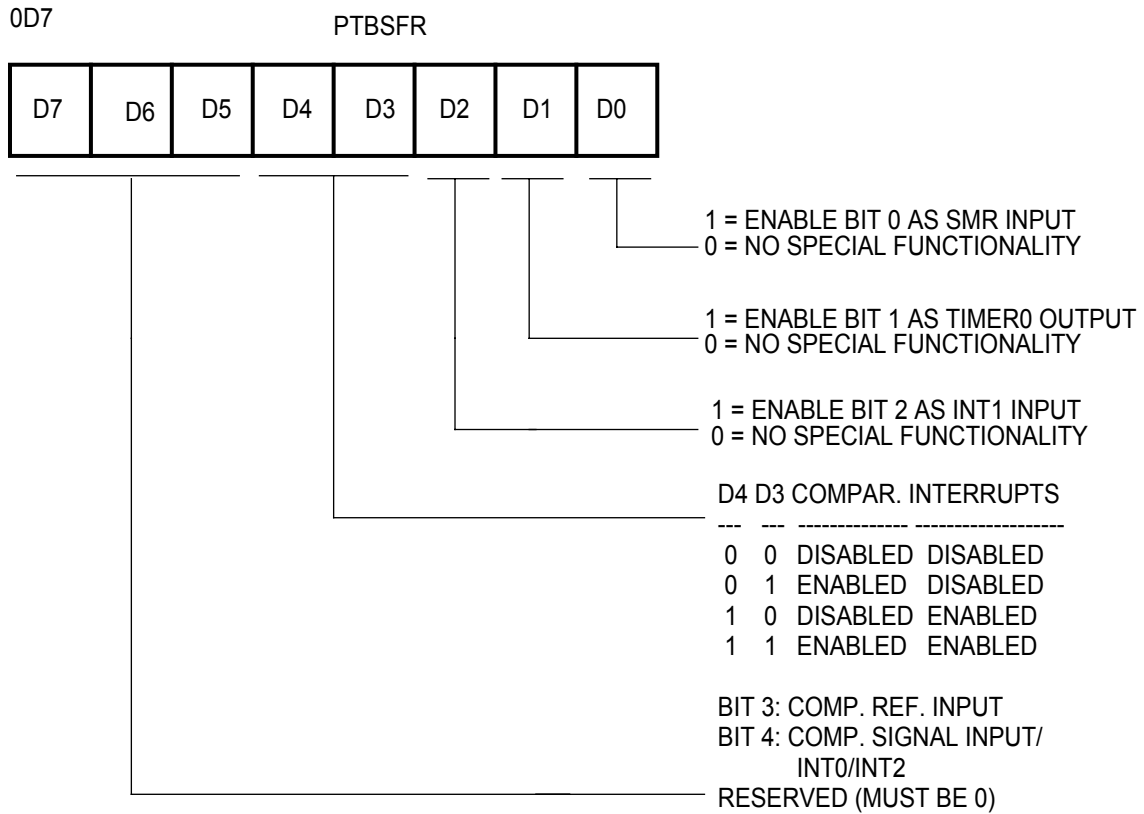


Figure 23. PortB Special Function Register (T_{out} Operation)

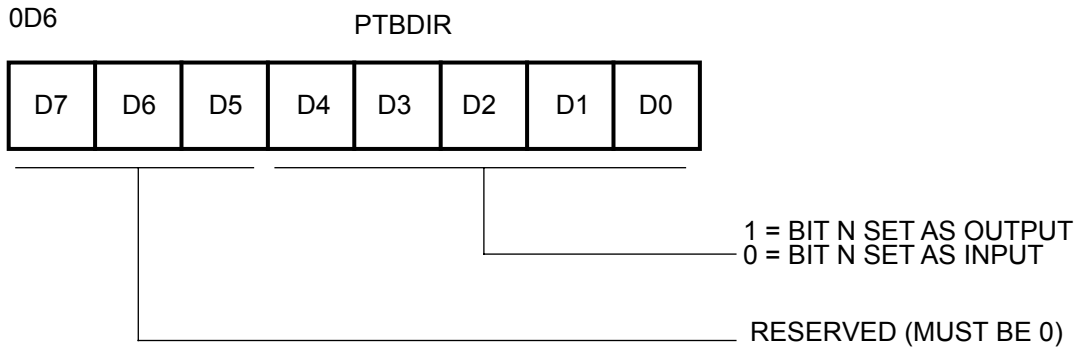


Figure 24. Port B Directional Control Register

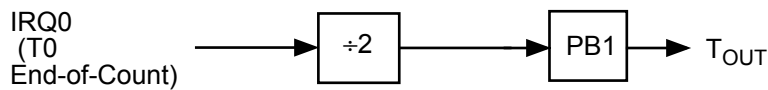


Figure 25. Timer T0 Output Through T_{OUT}

RESET CONDITIONS

After a hardware RESET, the timers are disabled. See Table 4 for timer control, value, and auto-initialization register status after RESET.

I/O PORTS

The Z8E001 has 13 lines dedicated to input and output. These lines are grouped into two ports known as Port A and Port B. Port A is an 8-bit port, bit programmable as either inputs or outputs. Port B can be programmed to provide standard input/output or the following special functions: timer0 output, comparator input, SMR input, and external interrupt inputs.

All ports have push-pull CMOS outputs. In addition, the outputs of Port A on a bit-wise basis can be configured for open-drain operation. The ports operate on a bit-wise basis. As such, the register values for/at a given bit position only affect the bit in question.

Each port is defined by a set of four control registers. See Figure 27.

Directional Control and Special Function Registers

Each port on the Z8E001 has a dedicated Directional Control Register that determines (on a bit-wise basis) whether a given port bit operates as either an input or an output.

Each port on the Z8E001 has a Special Function Register that, in conjunction with the Directional Control Register, implements (on a bit-wise basis), any special functionality that can be defined for each particular port bit.

READ/WRITE OPERATIONS

The control for each port is done on a bit-wise basis. All bits are capable of operating as inputs or outputs, depending upon the setting of the port's Directional Control Register. If configured as an input, each bit is provided a Schmitt-trigger. The output of the Schmitt-trigger is latched twice to perform a synchronization function, and the output of the synchronizer is fed to the port input register, which can be read by software.

A write to a port input register has the effect of updating the contents of the input register, but subsequent reads do not necessarily return the same value that was written. If the bit in question is defined as an input, the input register for

Table 7. Z8E001 I/O Ports Registers

Register	Address	Identifier
Port B Special Function	0D7H	PTBSFR
Port B Directional Control	0D6H	PTBDIR
Port B Output Value	0D5H	PTBOUT
Port B Input Value	0D4H	PTBIN
Port A Special Function	0D3H	PTASFR
Port A Directional Control	0D2H	PTADIR
Port A Output Value	0D1H	PTAOUT
Port A Input Value	0D0H	PTAIN

Input and Output Value Registers

Each port has an Output Value Register and a pF Input Value Register. For port bits configured as an input by means of the Directional Control Register, the Input Value Register for that bit position contains the current synchronized input value.

For port bits configured as an output by means of the Directional Control Register, the value held in the corresponding bit of the Output Value Register is driven directly onto the output pin. The opposite register bit for a given pin (the output register bit for an input pin and the input register bit for an output pin) holds their previous value. These bits are not changed and don't have any effect on the hardware.

that bit position contains the current synchronized input value. Thus, writes to that bit position is overwritten on the next clock cycle with the newly sampled input data. However, if the particular port bit is programmed as an output, the input register for that bit retains the software-updated value. The port bits that are programmed as outputs do not sample the value being driven out.

Any bit in either port can be defined as an output by setting the appropriate bit in the directional control register. If such is the case, the value held in the appropriate bit of the port output register is driven directly onto the output pin.

PORT B

Port B Description

Port B is a 5-bit (bidirectional), CMOS-compatible I/O port. These five I/O lines can be configured under software control to be an input or output, independently. Input buffers are Schmitt-triggered. See Figure 33 through Figure 36 for diagrams of all five Port B pins.

In addition to standard input/output capability on all five pins of Port B, each pin provides special functionality as shown in the following table:

Special functionality is invoked via the Port B Special Function Register. See Figure 32 for the arrangement and control conventions of this register.

Table 8. Port B Special Functions

Port Pin	Input Special Function	Output Special Function
PB0	Stop Mode Recovery Input	None
PB1	None	Timer0 Output
PB2	IRQ3	None
PB3	Comparator Reference Input	None
PB4	Comparator Signal Input/IRQ1/IRQ4	None

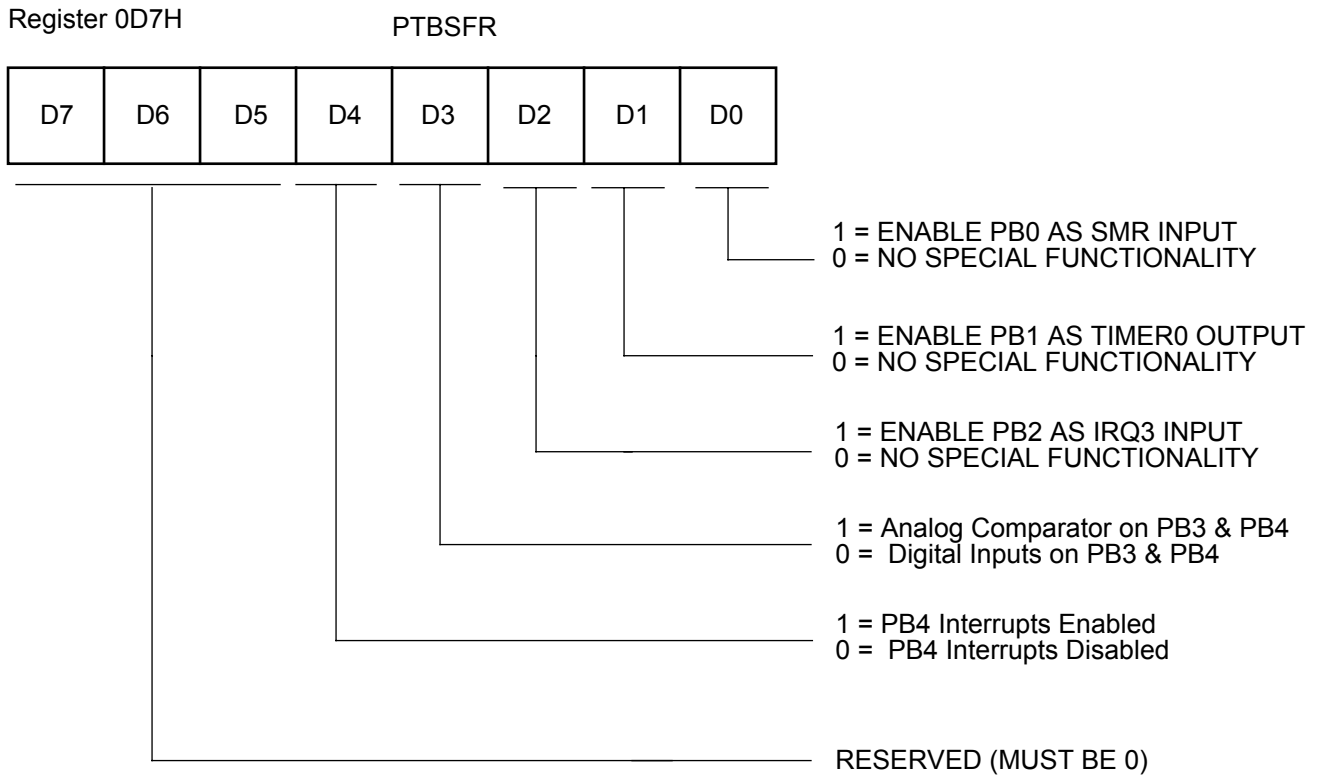


Figure 32. Port B Special Function Register

PORT B CONTROL REGISTERS

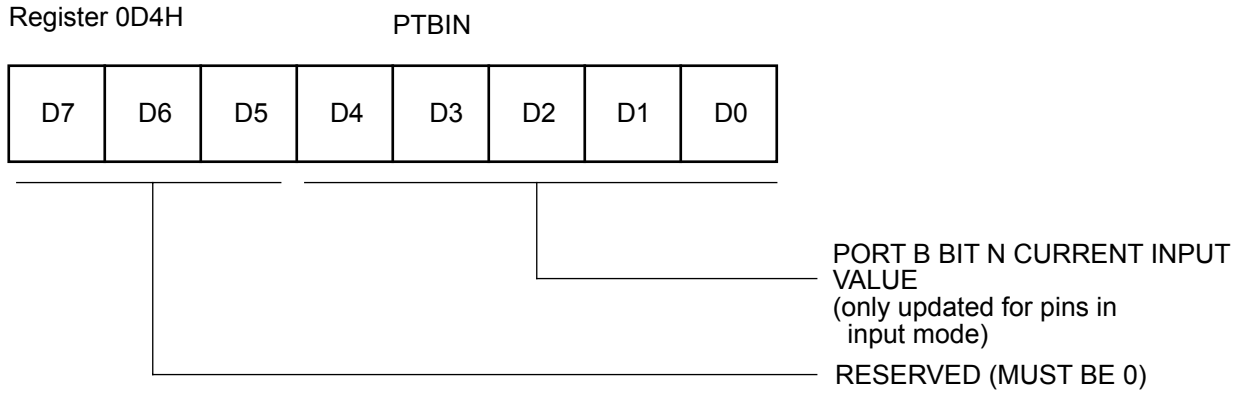


Figure 37. Port B Input Value Register

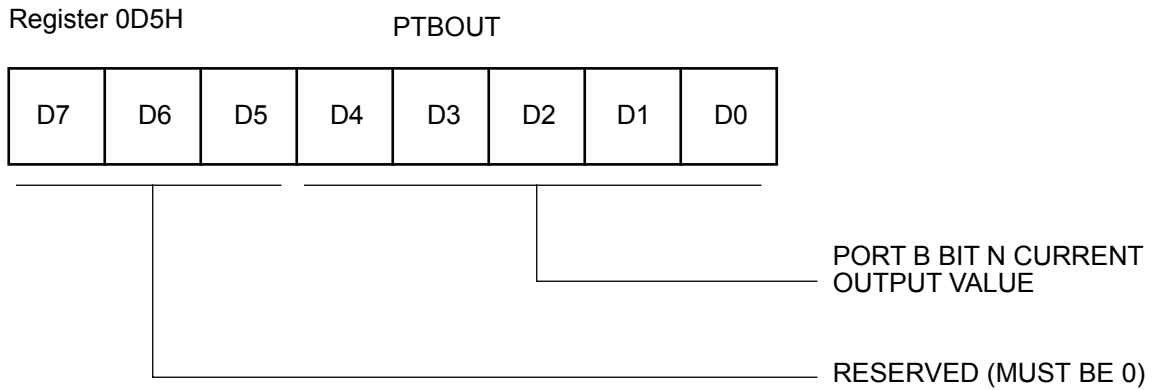


Figure 38. Port B Output Value Register

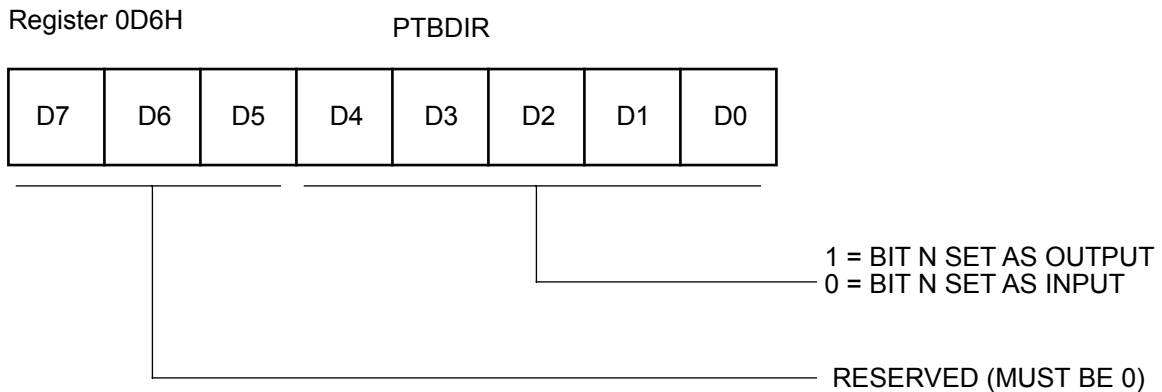


Figure 39. Port B Directional Control Register

PORT B CONTROL REGISTERS (Continued)

Register 0D7H

PTBSFR

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

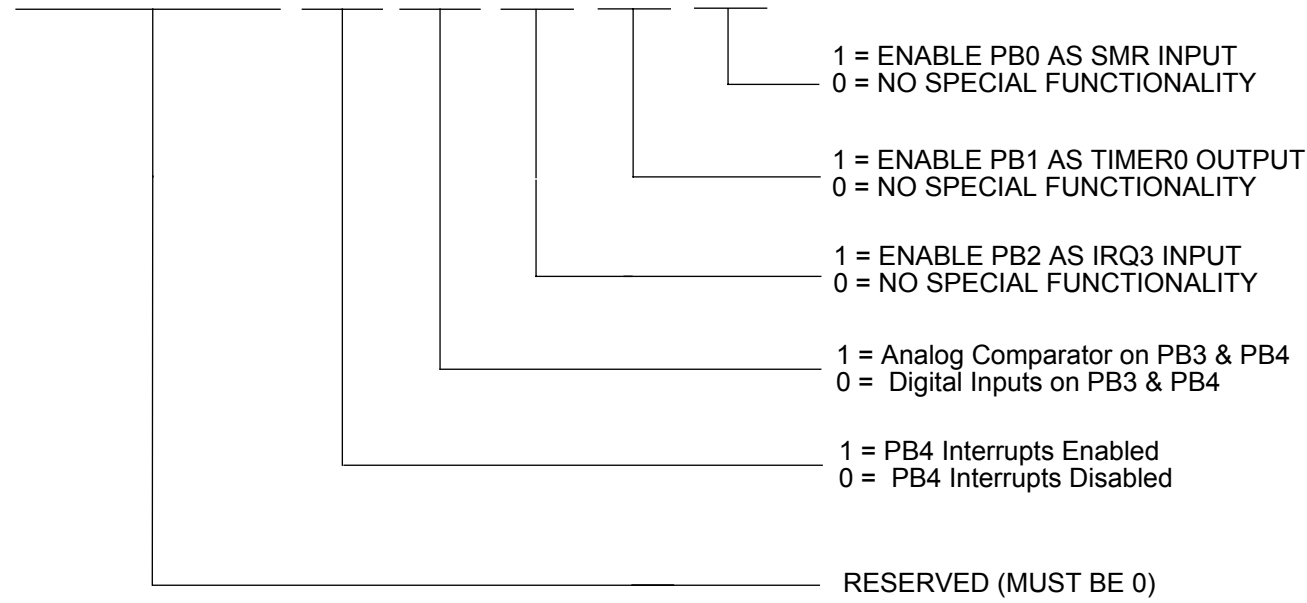


Figure 40. Port B Special Function Register

ORDERING INFORMATION

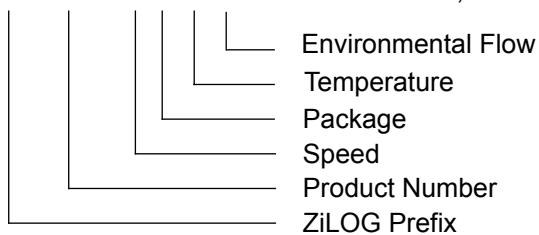
Standard Temperature	
18-Pin DIP	Z8E00110SSC
18-Pin SOIC	Z8E00110HSC
20-Pin SSOP	Z8E00110PSC
Extended Temperature	
18-Pin DIP	Z8E00110PEC
18-Pin SOIC	Z8E00110SEC
20-Pin SSOP	Z8E00110HEC

For fast results, contact your local ZiLOG sales office for assistance in ordering the part(s) required.

Codes	
Preferred Package	P = Plastic DIP
Longer Lead Time	S = SOIC H = SSOP
Preferred Temperature	S = 0°C to +70°C E = -40°C to +105°C
Speed	10 = 10 MHz
Environmental	C = Plastic Standard

Example:

Z 8E001 10 P S C is a Z86E001, 10 MHz, DIP, 0° to +70°C, Plastic Standard Flow



Pre-Characterization Product:

The product represented by this document is newly introduced and ZiLOG has not completed the full characterization of the product. The document states what ZiLOG knows about this product at this time, but additional features or non-conformance

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